

 <small>ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®</small>		<b>Material Composition Declaration</b> <small>© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.</small>		<small>This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.</small> <b>Adobe Reader version 7.0.5 is required to complete this declaration.</b>					
<b>1752-2 1.1</b>		IPC Web Site for Information on IPC-1752 Standard <a href="http://www.ipc.org/IPC-175x">http://www.ipc.org/IPC-175x</a>			<b>Form Type *</b> Distribute		<b>Declaration Class *</b> Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat		
<b>Supplier Information</b>									
<b>Company Name *</b> SEMTECH CORPORATION		Company Unique ID 00-847-9941		Unique ID Authority DUNS		<b>Response Date *</b> 2017-02-14		Response Document ID	
<b>Contact Name *</b> Roya Motamedi		Title - Contact Supervisor, QA Product Support		<b>Phone - Contact *</b> 805-498-2111		<b>Email - Contact *</b> rmotamedi@semtech.com		Duplicate Contact -> Authorized Representative	
<b>Authorized Representative *</b> Roya Motamedi		Title - Representative Supervisor, QA Product Support		<b>Phone - Representative *</b> 805-498-2111		<b>Email - Representative *</b> rmotamedi@semtech.com		Supplier Comments or URL for Additional Information	
Requester Item Number		Mfr Item Number		Mfr Item Name		Effective Date		Version	
		RClamp1644T.TNT						Manufacturing Site	
								Weight *	
								UOM	
								Unit Type	
Alternate Recommendation						Alternate Item Comments			
<b>Manufacturing Process Information</b>									
Terminal Plating / Grid Array Material				Terminal Base Alloy		J-STD-020 MSL Rating		Peak Process Body Temperature	
Nickel/Palladium/Gold (Ni/Pd/Au)				CU Alloy		1		260 C	
								Max Time at Peak Temperature	
								30 seconds	
								Number of Reflow Cycles	
								3	
Comments									
RClamp1644T.TNT is REACH-compliant product, per EU Regulation EC1907/2006 to include recent addition of SVHC candidate list of substances in January 2017.									

RoHS Material Composition Declaration

Declaration Type \*Detailed

RoHS Directive 2002/95/EC

RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.

RoHS Declaration \*1 - Item(s) does not contain RoHS restricted substances per the definition above

Supplier Acceptance \*Accepted

**Exemptions:** If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

Declaration Signature

**Instructions:** Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

# Homogeneous Material Composition Declaration for Electronic Products

**SubItem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

**Line Functions:** +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

			Item/SubItem Name				Homogeneous Material		Weight		Unit of Measure				Level		Substance Category				Substance		CAS		Exempt		Weight		Unit of Measure		Tolerance		PPM			
																															-	+				
+I	-I	Chip	+M	-M	Silicon Die	0.0739	mg	+C	-C	Supplier		+S	-S	Silicon (Si)	7440-21-3		0.0739	mg												52,449						
+I	-I	Lead Frame	+M	-M	C7025	0.534889	mg	+C	-C	Supplier		+S	-S	Copper (Cu)	7440-50-8		0.513	mg												363,96						
												+S	-S	Silicon (Si)	7440-21-3		0.0039	mg										2,752								
												+S	-S	Magnesium (Mg)	7439-95-4		0.0009	mg											664							
								+C	-C	B		+S	-S	Nickel	7440-02-0		0.0171	mg												12,145						
+I	-I	Lead Finish	+M	-M	Ni/Pd/Au plating	0.013715	mg	+C	-C	B	Nickel (external applic	+S	-S	Nickel	7440-02-0		0.0124	mg													8,775					
												+C	-C	Supplier		+S	-S	Palladium (Pd)	7440-05-3		0.0011	mg										798				
												+S	-S	Gold (Au)	7440-57-5		0.0002	mg															159			
+I	-I	Bonding Wire	+M	-M	Gold Wire	0.014	mg	+C	-C	Supplier		+S	-S	Gold (Au)	7440-57-5		0.014	mg													9,957					
+I	-I	Molding Compound	+M	-M	EME-G770H CD	0.732032	mg	+C	-C	Supplier		+S	-S	Silica Fused	60676-86-0		0.6845	mg													485,63					
												+S	-S	Epoxy Resin	Proprietary		0.022	mg															15,582			
												+S	-S	Phenol Resin	Proprietary		0.022	mg																	15,582	
												+S	-S	Carbon Black	1333-86-4		0.0037	mg																	2,597	
+I	-I	Die Attached Epoxy	+M	-M	QMI519	0.040792	mg	+C	-C	Supplier		+S	-S	Silver (Ag)	7440-22-4		0.0326	mg													23,155					
												+S	-S	Palladium compound	Proprietary		0.0001	mg																43		
												+S	-S	2,6-Di-tert-butyl-p-creso	128-37-0		0.000002	mg																	1	
												+S	-S	Hydroquinone	123-31-9		0.000000	mg																		0
												+S	-S	Acrylate	Proprietary		0.0065	mg																		4,586
												+S	-S	Bismaleimide resin	Proprietary		0.0012	mg																	868	
												+S	-S	Polymer of polybutadie	Proprietary		0.0004	mg																		289